

NSR10F30NXT5G

Schottky Barrier Diode

These Schottky barrier diodes are optimized for low forward voltage drop and low leakage current and are offered in a Chip Scale Package (CSP) to reduce board space. The low thermal resistance enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.

Features

- Low Forward Voltage Drop – 420 mV @ 1.0 A
- Low Reverse Current – 20 μ A @ 10 V VR
- 1.0 A of Continuous Forward Current
- ESD Rating – Human Body Model: Class 3B
– Machine Model: Class C
- High Switching Speed
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

Markets

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|-----------|--------------|---------|
| Reverse Voltage | V_R | 30 | V |
| Forward Current (DC) | I_F | 1.0 | A |
| Forward Surge Current (60 Hz @ 1 cycle) | I_{FSM} | 18 | A |
| Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 66%) | I_{FRM} | 4.0 | A |
| ESD Rating: Human Body Model Machine Model | ESD | > 8 > 400 | kV V |

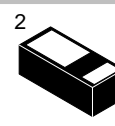
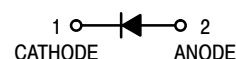
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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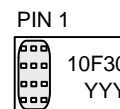
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30 V SCHOTTKY BARRIER DIODE

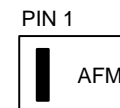


DSN2 (0502)
CASE 152AD

MARKING DIAGRAM



10F30 = Specific Device Code
YYY = Year Code



AF = Specific Device Code
M = Month Code

ORDERING INFORMATION

| Device | Package | Shipping† |
|---------------|----------------|--------------------|
| NSR10F30NXT5G | DSN2 (Pb-Free) | 5000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSR10F30NXT5G

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Min | Typ | Max | Unit |
|--|--------------------------|-----|-----|-------------|---------------------------------|
| Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ $T_A = 25^\circ\text{C}$ | $R_{\theta JA}$ P_D | | | 228 548 | $^\circ\text{C}/\text{W}$ mW |
| Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ $T_A = 25^\circ\text{C}$ | $R_{\theta JA}$ P_D | | | 85 1.47 | $^\circ\text{C}/\text{W}$ W |
| Storage Temperature Range | T_{stg} | | | -40 to +125 | $^\circ\text{C}$ |
| Junction Temperature | T_J | | | +150 | $^\circ\text{C}$ |

- Mounted onto a 4 in square FR-4 board 50 mm sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.
- Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|--------|-----|----------------|----------------|---------------|
| Reverse Leakage ($V_R = 10\text{ V}$) ($V_R = 30\text{ V}$) | I_R | | | 20 100 | μA |
| Forward Voltage ($I_F = 0.5\text{ A}$) ($I_F = 1.0\text{ A}$) | V_F | | 0.400 0.450 | 0.420 0.470 | V |

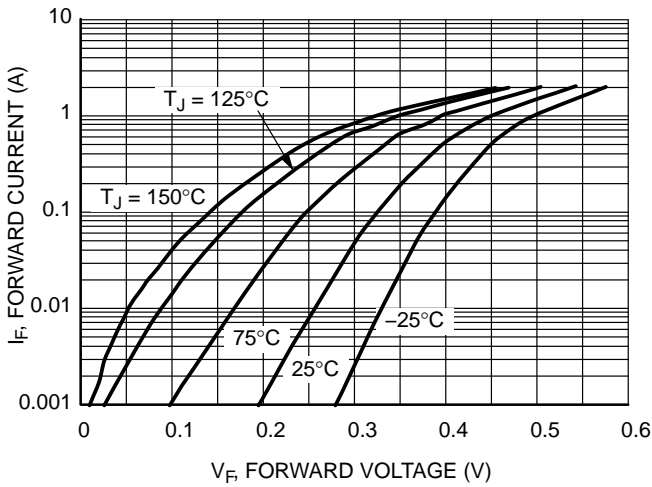


Figure 1. Forward Voltage

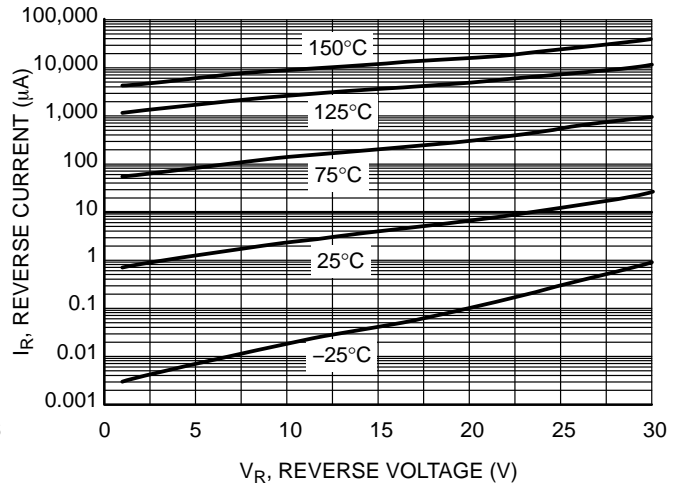


Figure 2. Typical Reverse Current

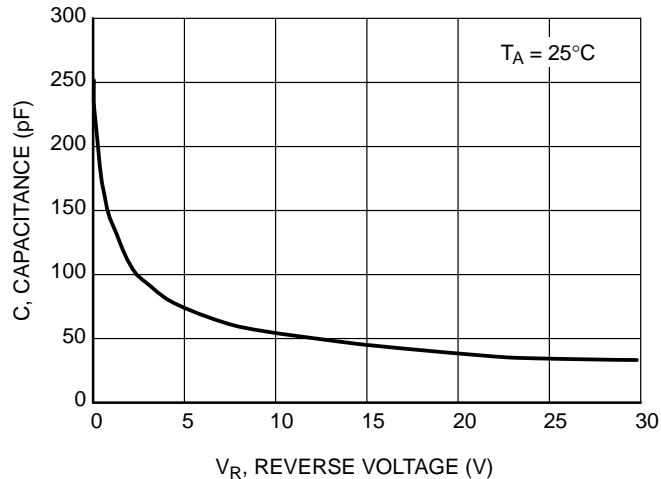
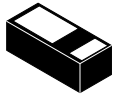


Figure 3. Typical Capacitance

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

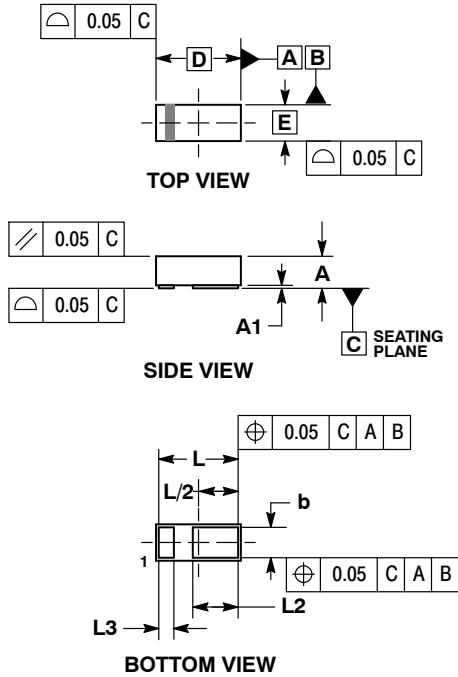
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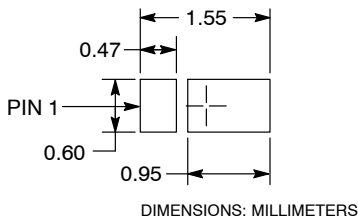
SCALE 8:1

DSN2, 1.4x0.6, 0.75P
CASE 152AD
ISSUE C

DATE 24 APR 2017



MOUNTING FOOTPRINT*



See Application Note AND8464/D for more mounting details

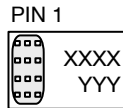
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.

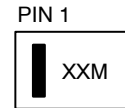
| MILLIMETERS | | |
|-------------|----------|------|
| DIM | MIN | MAX |
| A | 0.25 | 0.31 |
| A1 | --- | 0.05 |
| b | 0.45 | 0.55 |
| D | 1.40 BSC | |
| E | 0.60 BSC | |
| L | 1.20 | 1.30 |
| L2 | 0.70 | 0.80 |
| L3 | 0.20 | 0.30 |

GENERIC MARKING DIAGRAM1*



XXXX = Specific Device Code
YYY = Year Code

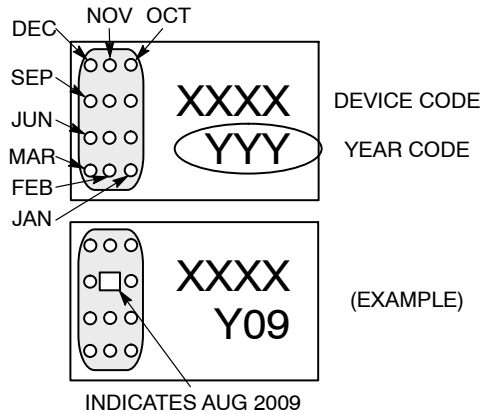
GENERIC MARKING DIAGRAM2*



XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present. Some products may not follow the Generic Marking.

CATHODE BAND MONTH CODING



| | | |
|-------------------------|-----------------------------|--|
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| DESCRIPTION: | DSN2, 1.4X0.6, 0.75P | PAGE 1 OF 1 |

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